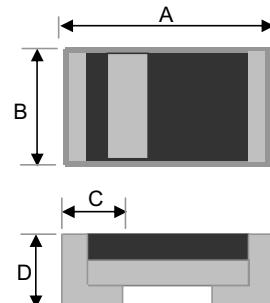


Small Signal Diode


1206


Features

- ◊ Designed for mounting on small surface.
- ◊ Extremely thin/leadless package
- ◊ High mounting capability, strong surge with stand, high reliability.
- ◊ Pb free version and RoHS compliant
- ◊ Halogen free

Mechanical Data

- ◊ Case :1206 standard package, molded plastic
- ◊ Terminal: Gold plated, solderable per MIL-STD-750, method 2026 guaranteed
- ◊ High temperature soldering guaranteed: 260°C/10s
- ◊ Polarity : Indicated by cathode band
- ◊ Weight : 0.010 gram (approximately)

Dimensions	Unit (mm)		Unit (inch)	
	Min	Max	Min	Max
A	3.00	3.40	0.118	0.134
B	1.30	1.70	0.051	0.067
C	0.35	0.75	0.014	0.030
D	0.75	0.95	0.030	0.037

Ordering Information

Part No.	Package	Packing
TS4148 RXG	1206	5Kpcs / 7" Reel

Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified.

Maximum Ratings

Type Number	Symbol	Value	Units
Power Dissipation	P _D	400	mW
Non-Repetitive Peak Reverse Voltage	V _{RSM}	100	V
Repetitive Peak Reverse Voltage	V _{RRM}	75	V
Repetitive Peak Forward Current	I _{FRM}	300	mA
Mean Forward Current	I _o	150	mA
Non-Repetitive Peak Forward Surge Current Tp=1sec square waveform 8.3ms single half sine waveform	I _{FSM}	0.5 2.0	A
Thermal Resistance (Junction to Ambient) (Note 1)	R _{θJA}	375	°C/W
Junction and Storage Temperature Range	T _J , T _{STG}	-65 to + 175	°C

Electrical Characteristics

Type Number	Symbol	Min	Max	Units
Reverse Breakdown Voltage (Note 2)	V _(BR)	-	75	V
Forward Voltage I _F = 10mA	V _F	-	1.00	V
Reverse Leakage Current V _R = 20V V _R = 75V	I _R	-	25	nA
		-	5	μA
Junction Capacitance V _R =0, f=1.0MHz	C _J		4.0	pF
Reverse Recovery Time (Note3)	T _{rr}		4	ns

Notes:1. Valid provided that electrodes are kept at ambient temperature

Notes:2. Test Condition : I_R=100μA

Notes:3. Test Condition : I_F=10mA, I_R=1mA, R_L=100Ω

Small Signal Diode

Rating and Shacteristic Curves

FIG 1 Typical Forward Characteristics

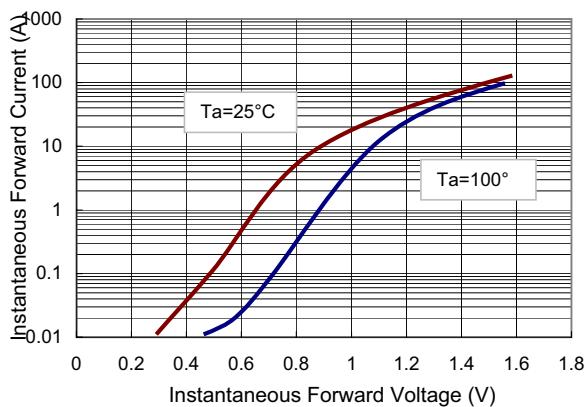


FIG 2 Reverse Current vs Reverse Voltage

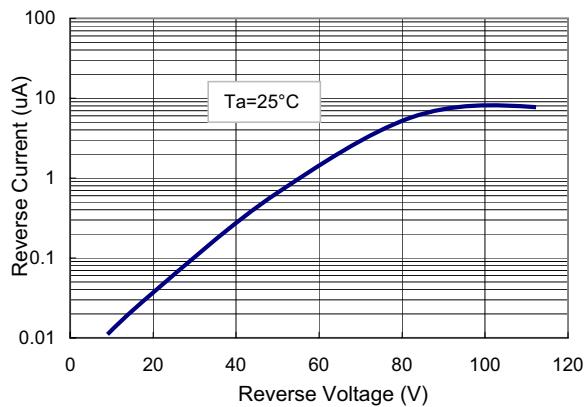


FIG 3 Admissible Power Dissipation Curve

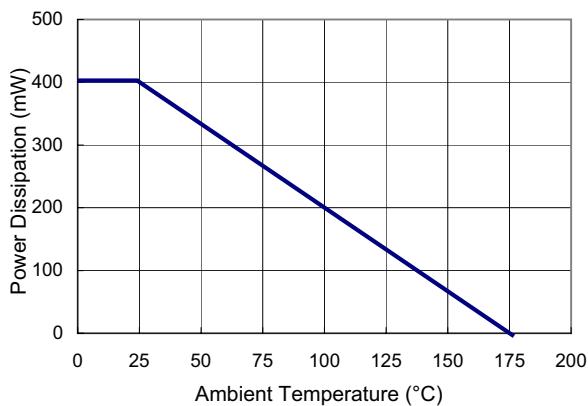


FIG 4 Typical Junction Capacitance

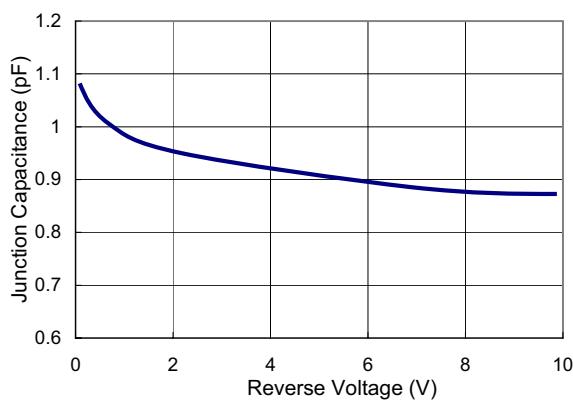


FIG 5 Forward Resistance vs. Forward Current

